# Cascade Microtech, Inc.

# **SPECIFICATION SHEET**



	HF	and	DC	bias	sing	
	on	one	Pro	beH	ead	

# HFPROBEWEDGE

# **High-Frequency Wafer Probe**

To give you the highest degree of application flexibility when performing functional on-wafer high-frequency tests, Cascade Microtech developed the HF ProbeWedges, which use both RF contacts and DC blade needles. To ensure accurate and repeatable measurements, the overtravel of the DC blade needles has been matched with the touch down of the MEMS-machined |Z| Probes®. The HF ProbeWedge is ideal for small pads down to 40 µm x 40 µm and pitches as small as 100 µm.

The variety of available configurations of the HF ProbeWedge ensures your application requirements are met every time. Mounted on a PCB board, the renowned |Z| Probes can be combined with up to four DC probes on each side. For all differential measurement tasks, unique Dual |Z| Probe is available as an HF ProbeWedge with a maximum of two DC probes on each side of the probe tip.

The unique design of the PCB board of the HF ProbeWedge and the housing of the |Z| Probe ensure an optimum size of the ProbeWedge to fit onto any standard high frequency probe arm just like any other RF probes. This means that you will not need to make any unnecessary adjustments to the probe arm or the manipulator (e.g. ProbeHead™ PH110HF or PH250) itself on the platen.

Furthermore, our unique plug and play concept of DC cables and connectors for the HF ProbeWedge no longer requires any soldering of the cables to the ProbeWedge. They are easily plugged into the carrier (different sizes are available) and held firmly in place by a one-click holding mechanism that allows the cables to be easily removed at any time. This saves the operator time when changing between different measurement tasks and money because all cables can be reused.

All HF ProbeWedges can be used in shielded environments such as the ProbeShield® Operating Environment and any other standard HF probers. The PCB board on the HF ProbeWedge can be customized to ensure that any required integrated elements, such as a surface mounted device (SMD), can be incorporated into the design. Other customized solutions are available on request.

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Ease of use	Fits all standard HF probe arms without any adjustments				
	Can be used on a standard prober or in shielded environments				
	Small carrier interface provides plug and play capabilities for all DC cables without soldering the cables to the ProbeWedge				
	DC needles can be repaired individually				
Flexibility	Specially designed for DC-biasing with  Z  Probe				
	Easy and fast change-over between different test setups				
	Differential measurements supported with Dual  Z  Probe				
Accuracy	Utilizes design of MEMS-machined  Z  Probes to ensure planar contact to the DUT at all times				
	Independent contacts of the  Z  Probe compensate for pad height differences up to 50 $\mu m$				

### FEATURES AND BENEFITS

Available Signal Configuration	ons		
One HF signal combined with	n 2 x 2 DC signals		
	GS/SG	GSG	
Frequency	Up to 10 GHz	Up to 50 GHz	
Pitch	100 μm to 1250 μm	50 μm to 1250 μm (up to 40 GHz)	
		50 μm to 5000 μm (up to 50 GHz)	
Housing	Standard	Standard	
One HF signal combined with	n 2 x 4 DC signals		
	GS/SG	GSG	
Frequency	Up to 10 GHz	Up to 50 GHz	
Pitch	100 μm to 1250 μm	50 μm to 1250 μm (up to 40 GHz)	
		50 μm to 5000 μm (up to 50 GHz)	
Housing	Small	Small	
Two HF signals combined wi	th 2 x 2 DC signals		
	GSGSG	GSSG/SGS	
Frequency	Up to 40 GHz	Up to 10 GHz	
Pitch (µm)	100, 125, 150, 200, 250 and 500 μm	100, 125, 150, 200, 250 and 500 μm	
Housing	Standard	Standard	
DC blades	Metal blades (simple DC)	Metal blades (simple DC)	
	Ceramic blades (low capacitance and high isolation)	Ceramic blades (low capacitance and high isolation)	
	Microstrip (low noise, low resistance) 50, Kelvin, triax	Microstrip (low noise, low resistance) 50, Kelvin, triax	
DC needles	Tungsten (standard), Berillium-copper (option)	Tungsten (standard), Berillium-copper (option)	
	Tip size: 35 μm to 40 μm (1.5 nil)	Tip size: 35 μm to 40 μm (1.5 nil)	
Operating temperatures	-60 °C to 125 °C	-60 °C to 125 °C	

\*Data, design and specification depend on individual process conditions and can vary according to equipment configurations. Not all specifications may be valid simultaneously.

## PHYSICAL DIMENSIONS





Top view

Side view

#### **APPLICATIONS**



HF ProbeWedge with |Z| Probe GSG and three DC metal blades on each side.



Close-up of |Z| Probe and DC needle tips as in above mentioned configuration.

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Data subject to change without notice

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